

1200V SiC Schottky Diode

VDC	1200 V
Q _C	318 nC***
I _F	60 A***
T _{j,max}	175 °C

Amp+™ Features

- Unipolar rectifier with surge current
- Zero reverse recovery current
- Fast, temperature-independent switching
- Avalanche tested to 400mJ per leg*
- All parts tested to greater than 1,400V

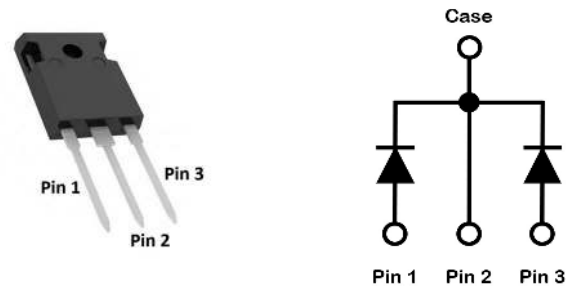
Amp+™ Benefits

- Near zero switching loss
- Higher efficiency
- Smaller heat sink
- Easy to parallel

Amp+™ Applications

- Solar Inverters
- Switch mode power supplies, UPS
- Power factor correction
- EV charging stations

Package



Part #	Package	Marking
GP3D060A120U	TO-247-3L	3D060A120



Maximum Ratings, at T_j=25 °C, unless otherwise specified

Characteristics Per Leg	Symbol	Conditions	Values	Unit
Continuous forward current	I _{F**}	T _C =25 °C, T _J =175 °C	74	A
		T _C =125 °C, T _J =175 °C	40	
		T _C =150 °C, T _J =175 °C	26	
Surge non-repetitive forward current sine halfwave	I _{FSM}	T _C =25 °C, t _p =8.3 ms	265	A
		T _C =110 °C, t _p =8.3 ms	240	
Non-repetitive peak forward current	I _{F,max}	T _C =25 °C, t _p =10 μs	1500	A
i ² t value	∫i ² dt	T _C =25 °C, t _p =8.3 ms	291	A ² s
		T _C =110 °C, t _p =8.3 ms	239	
Repetitive peak reverse voltage	V _{RRM}	T _J =25 °C	1200	V
Diode dv/dt ruggedness	dv/dt	Turn-on slew rate, repetitive	200	V/ns
Power dissipation	P _{tot**}	T _C =25 °C	321	W
Operating junction & storage temperature	T _j , T _{storage}	Continuous	-55...175	°C
Soldering temperature	T _{solder}	Wave soldering leads	260	°C
Mounting torque		M3 Screw	1	N-m

Notes:

* EAS of 400 mJ is based on starting T_j = 25°C, L = 1.0 mH, IAS = 28.28 A, V = 50 V.

** Typical R_{thJC} used

*** Per Device

Electrical Characteristics, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Characteristics Per Leg	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
DC blocking voltage	V_{DC}	$T_j=25\text{ }^\circ\text{C}$	1200	-	-	V
Breakdown voltage	V_{BR}	$I_R=1.00\text{mA}$, $T_j=25\text{ }^\circ\text{C}$	1400	-	-	V
Diode forward voltage	V_F	$I_F=30\text{A}$, $T_j=25\text{ }^\circ\text{C}$	-	1.54	1.70	V
		$I_F=30\text{A}$, $T_j=125\text{ }^\circ\text{C}$	-	1.92	-	
		$I_F=30\text{A}$, $T_j=175\text{ }^\circ\text{C}$	-	2.23	2.70	
Reverse current	I_R	$V_R=1,200\text{V}$, $T_j=25\text{ }^\circ\text{C}$	-	2	60	μA
		$V_R=1,400\text{V}$, $T_j=25\text{ }^\circ\text{C}$	-	9	-	
		$V_R=1,200\text{V}$, $T_j=125\text{ }^\circ\text{C}$	-	15	-	
		$V_R=1,200\text{V}$, $T_j=175\text{ }^\circ\text{C}$	-	69	900	
Total capacitive charge	Q_C	$V_R=800\text{V}$, $T_j=25\text{ }^\circ\text{C}$	-	159	-	nC
Total capacitance	C	$V_R=1\text{V}$, $f=1\text{ MHz}$	-	1762	-	pF
		$V_R=400\text{V}$, $f=1\text{ MHz}$	-	150	-	
		$V_R=800\text{V}$, $f=1\text{ MHz}$	-	108	-	

Thermal Characteristics

Characteristics Per Leg	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Thermal resistance, junction-case	R_{thJC}	-	-	0.47	0.62	$^\circ\text{C/W}$

Typical Performance Per Leg

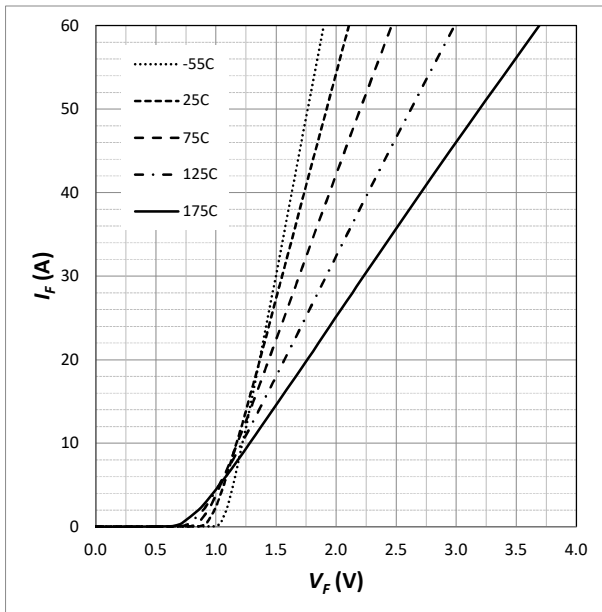


Fig. 1 Forward Characteristics (parameterized on T_j)

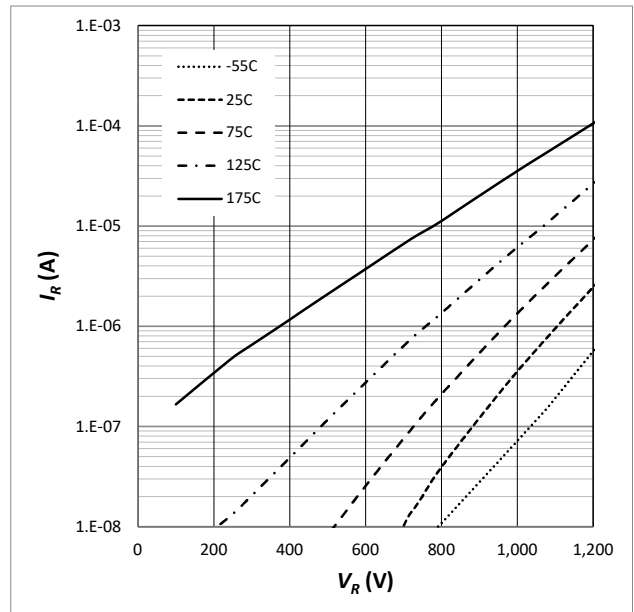


Fig. 2 Reverse Characteristics (parameterized on T_j)

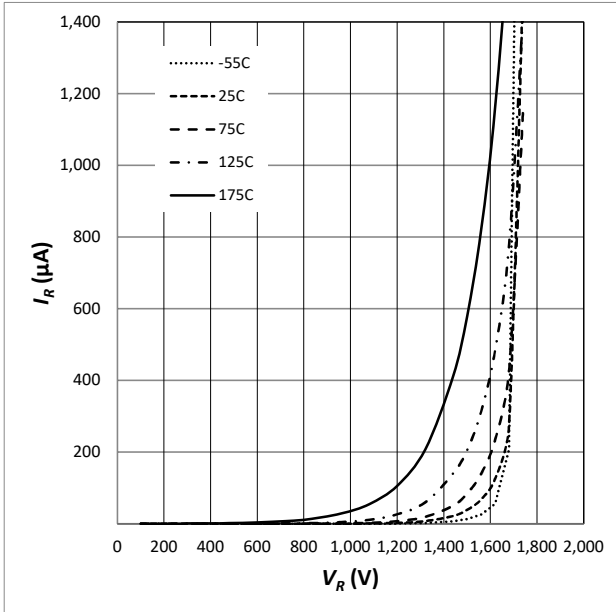


Fig. 3 Reverse Characteristics (parameterized on T_j)

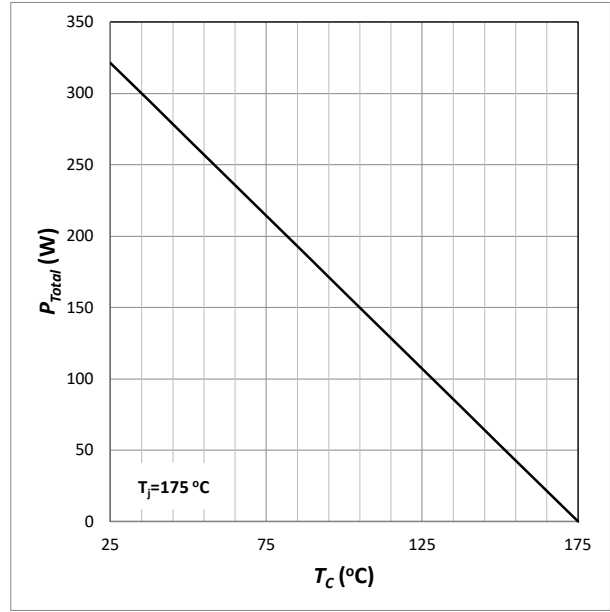


Fig. 4 Power Derating

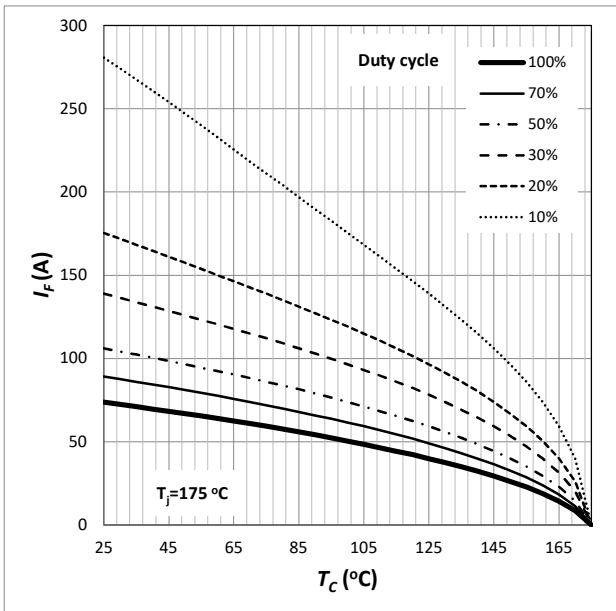


Fig. 5 Capacitance

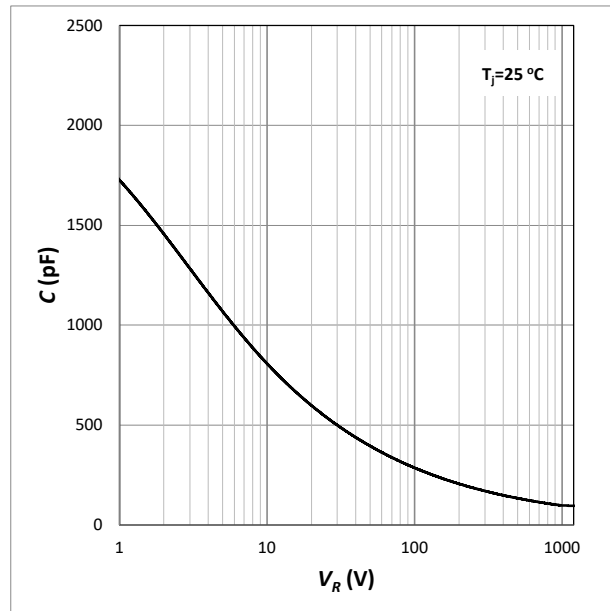


Fig. 6 Capacitance

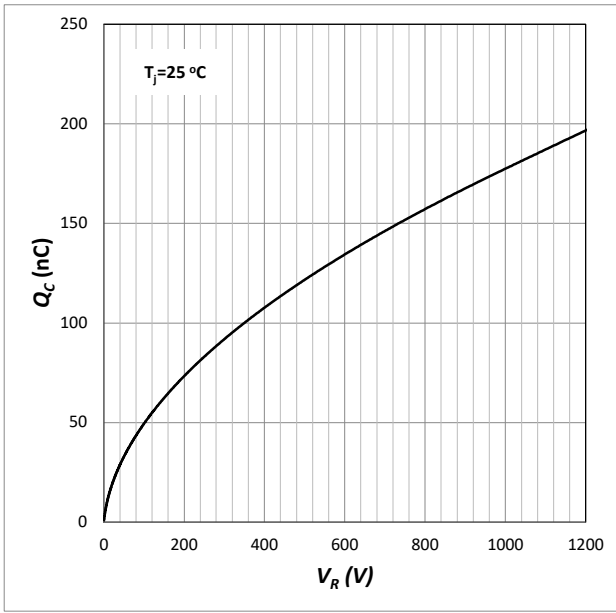


Fig. 7 Capacitive Charge

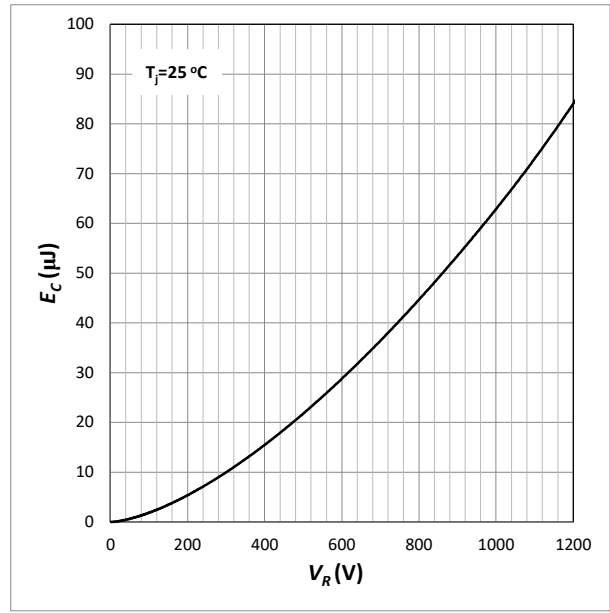


Fig. 8 Typical Capacitance Stored Energy

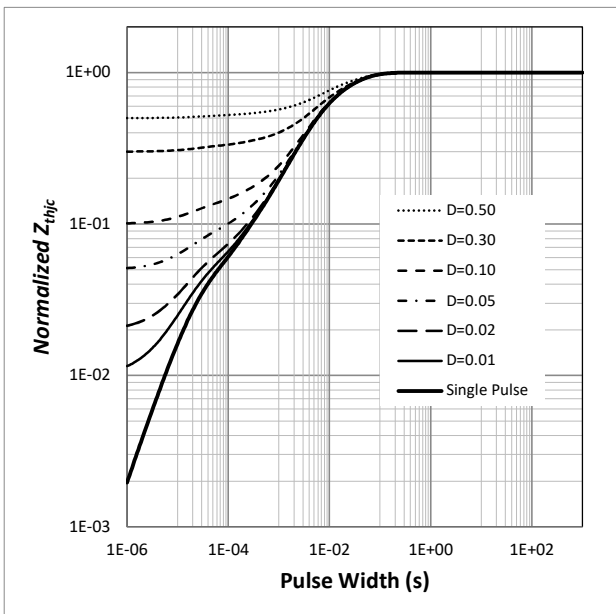


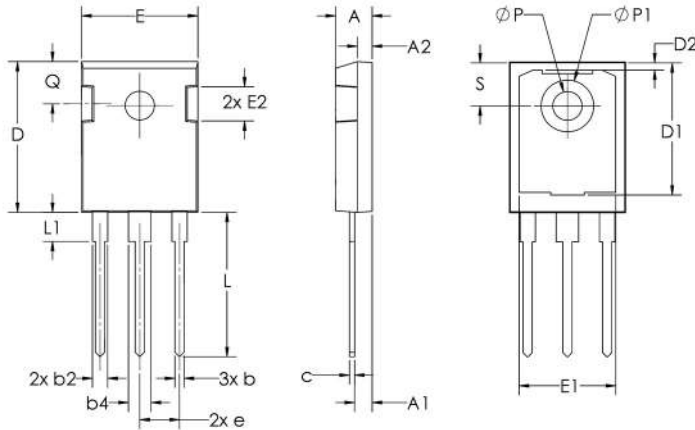
Fig. 9 Transient Thermal Impedance

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Amp+™

GP3D060A120U

Package Dimensions TO-247-3L



Sym	Millimeters		Inches	
	Min	Max	Min	Max
A	4.70	5.31	0.185	0.209
A1	2.21	2.59	0.087	0.102
A2	1.50	2.49	0.059	0.098
b	0.99	1.40	0.039	0.055
b2	1.65	2.39	0.065	0.094
b4	2.59	3.43	0.102	0.135
c	0.38	0.89	0.015	0.035
D	20.80	21.46	0.819	0.845
D1	13.08	17.65	0.515	0.695
D2	0.51	1.35	0.020	0.053
E	15.49	16.26	0.610	0.640
E1	13.46	14.16	0.530	0.557
E2	3.43	5.49	0.135	0.216
e	5.44 BSC		0.214 BSC	
L	19.81	20.32	0.780	0.800
L1	4.10	4.50	0.161	0.177
ØP	3.56	3.66	0.140	0.144
ØP1	7.06	7.39	0.278	0.291
Q	5.39	6.20	0.212	0.244
S	6.04	6.30	0.238	0.248

Notes

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented March, 2013. RoHS Declarations for this product can be obtained from the Product Documentation sections of www.SemiQ.com.

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